

BOSTIK SA 420 rue d'Estienne d'Orves 92700 Colombes France

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Registration may be verified at nsfwhitebook.org



Samuel Cole NSF Nonfood Compounds Registration Program Company No: C0593693

Certificate of Registration

BOSTIK SA has achieved Registration status for Bostik Born2Bond Repair Part A to the NSF International Registration Guidelines for Proprietary Substances and Nonfood Compounds (2022).

Bostik Born2Bond Repair Part A

Category Code: S4

NSF Registration No. 171206

This product is acceptable for use as an adhesive (S4) in and around food processing areas. The product must only be used in such a manner as to ensure it will have neither direct nor indirect contact with food or potable water. Before using this compound, food products and packaging materials must be removed from the area or carefully protected. This compound must be used in a manner so that all odors associated with the compound are dissipated before food products or packaging materials are re-exposed in the area. Use must also be consistent with the manufacturer"s directions and warnings.

Registration of this product is current when the NSF Registration Mark and Category Code appear on the product label reviewed by NSF, and the Registered product name is in the NSF White Book[™] (www.nsfwhitebook.org).

Listing of all registered nonfood compounds by NSF International is not an endorsement of those compounds or of any performance or efficacy claims made by the manufacturer.